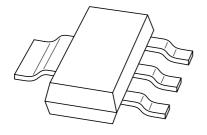
# DISCRETE SEMICONDUCTORS

# DATA SHEET



# **BZV90 series**Voltage regulator diodes

Product data sheet Supersedes data of 1996 Oct 25 1999 May 17



# Voltage regulator diodes

#### **BZV90** series

#### **FEATURES**

- Total power dissipation: max. 1500 mW
- Tolerance series: approx. ±5%
- Working voltage range: nom. 2.4 to 75 V (E24 range)
- Non-repetitive peak reverse power dissipation: max. 40 W.

#### **APPLICATIONS**

• General regulation functions.

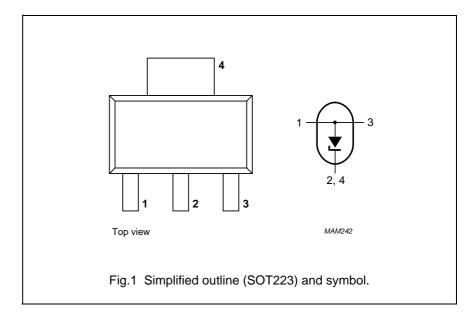
#### **DESCRIPTION**

Medium-power voltage regulator diodes in SOT223 plastic SMD packages.

The diodes are available in the normalized E24 approx.  $\pm 5\%$  tolerance range. The series consists of 37 types with nominal working voltages from 2.4 to 75 V (BZV90-C2V4 to C75).

#### **PINNING**

PIN	DESCRIPTION
1	anode
2, 4	cathode
3	anode



#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>F</sub>	continuous forward current		_	400	mA
I <sub>ZSM</sub>	non-repetitive peak reverse current	$t_p$ = 100 μs; square wave; $T_j$ = 25 °C prior to surge	see Table "Per type"		
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; note 1	_	1500	mW
P <sub>ZSM</sub>	non-repetitive peak reverse power dissipation	$t_p$ = 100 μs; square wave; $T_j$ = 25 °C prior to surge; see Fig.2	_	40	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

#### Note

1. Device mounted on an FR4 double-sided copper-clad printed circuit-board; copper area = 2 cm<sup>2</sup>.

#### **ELECTRICAL CHARACTERISTICS**

#### **Total series**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA; see Fig.3	I	1.0	V

Voltage regulator diodes

BZV90 series

Per type  $T_j = 25 \, ^{\circ}\text{C unless otherwise specified.}$ 

BZV90- CXXX		ΓAGE (V)	RESIS r <sub>di</sub>	RENTIAL STANCE <sub>if</sub> (Ω) I <sub>Ztest</sub>	s	IP. COI z (mV/I at I <sub>Ztest</sub> Figs 4 a	<b>&lt;</b> )	TEST CURRENT I <sub>Ztest</sub> (mA)	DIODE CAP. $C_{d} (pF)$ at f = 1 MHz; at $V_{R} = 0 \ V$	REVER CURREI REVER VOLTA	NT at RSE	NON-REPETITIVE PEAK REVERSE CURRENT $I_{ZSM}$ (A) at $t_p = 100 \mu s$ ;		
										I <sub>R</sub> (μA) V <sub>R</sub>		I <sub>R</sub> (μA) V <sub>R</sub>		T <sub>amb</sub> = 25 °C
	MIN.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.		MAX.	MAX.	(V)	MAX.		
2V4	2.2	2.6	70	100	-3.5	-1.6	0	5	450	50	1.0	6.0		
2V7	2.5	2.9	75	100	-3.5	-2.0	0	5	450	20	1.0	6.0		
3V0	2.8	3.2	80	95	-3.5	-2.1	0	5	450	10	1.0	6.0		
3V3	3.1	3.5	85	95	-3.5	-2.4	0	5	450	5	1.0	6.0		
3V6	3.4	3.8	85	90	-3.5	-2.4	0	5	450	5	1.0	6.0		
3V9	3.7	4.1	85	90	-3.5	-2.5	0	5	450	3	1.0	6.0		
4V3	4.0	4.6	80	90	-3.5	-2.5	0	5	450	3	1.0	6.0		
4V7	4.4	5.0	50	80	-3.5	-1.4	0.2	5	300	3	2.0	6.0		
5V1	4.8	5.4	40	60	-2.7	-0.8	1.2	5	300	2	2.0	6.0		
5V6	5.2	6.0	15	40	-2.0	1.2	2.5	5	300	1	2.0	6.0		
6V2	5.8	6.6	6	10	0.4	2.3	3.7	5	200	3	4.0	6.0		
6V8	6.4	7.2	6	15	1.2	3.0	4.5	5	200	2	4.0	6.0		
7V5	7.0	7.9	6	15	2.5	4.0	5.3	5	150	1	5.0	4.0		
8V2	7.7	8.7	6	15	3.2	4.6	6.2	5	150	0.7	5.0	4.0		
9V1	8.5	9.6	6	15	3.8	5.5	7.0	5	150	0.5	6.0	3.0		
10	9.4	10.6	8	20	4.5	6.4	8.0	5	90	0.2	7.0	3.0		
11	10.4	11.6	10	20	5.4	7.4	9.0	5	85	0.1	8.0	2.5		
12	11.4	12.7	10	25	6.0	8.4	10.0	5	85	0.1	8.0	2.5		
13	12.4	14.1	10	30	7.0	9.4	11.0	5	80	0.1	8.0	2.5		
15	13.8	15.6	10	30	9.2	11.4	13.0	5	75	0.05	10.5	2.0		
16	15.3	17.1	10	40	10.4	12.4	14.0	5	75	0.05	11.2	1.5		
18	16.8	19.1	10	45	12.4	14.4	16.0	5	70	0.05	12.6	1.5		
20	18.8	21.2	15	55	14.4	16.4	18.0	5	60	0.05	14.0	1.5		

Product data sheet

BZV90- CXXX	VOL <sup>*</sup>	KING TAGE (V) Ztest	RESI:	RENTIAL STANCE $_{if}(\Omega)$	S	MP. CO z (mV/l at I <sub>ztes</sub> Figs 4 a	K) t	TEST CURRENT I <sub>Ztest</sub> (mA)	DIODE CAP. $C_{d} (pF)$ at f = 1 MHz; at $V_{R} = 0 \ V$	REVER CURRE REVER VOLTA	NT at RSE	NON-REPETITIVE PEAK REVERSE CURRENT $I_{ZSM}$ (A) at $t_p$ = 100 $\mu$ s;
0,000							<b>I</b> <sub>R</sub> (μ <b>A</b> )	$V_R$	T <sub>amb</sub> = 25 °C			
	MIN.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.		MAX.	MAX.	(V)	MAX.
22	20.8	23.3	20	55	16.4	18.4	20.0	5	60	0.05	15.4	1.25
24	22.8	25.6	25	70	18.4	20.4	22.0	5	55	0.05	16.8	1.25
27	25.0	28.9	25	80	21.4	23.4	25.3	2	50	0.05	18.9	1.0
30	28.0	32.0	30	80	24.4	26.6	29.4	2	50	0.05	21.0	1.0
33	31.0	35.0	35	80	27.4	29.7	33.4	2	45	0.05	23.1	0.9
36	34.0	38.0	35	90	30.4	33.0	37.4	2	45	0.05	25.2	0.8
39	37.0	41.0	40	130	33.4	36.4	41.2	2	45	0.05	27.3	0.7
43	40.0	46.0	45	150	37.6	41.2	46.6	2	40	0.05	30.1	0.6
47	44.0	50.0	50	170	42.0	46.1	51.8	2	40	0.05	32.9	0.5
51	48.0	54.0	60	180	46.6	51.0	57.2	2	40	0.05	35.7	0.4
56	52.0	60.0	70	200	52.2	57.0	63.8	2	40	0.05	39.2	0.3
62	58.0	66.0	80	215	58.8	64.4	71.6	2	35	0.05	43.4	0.3
68	64.0	72.0	90	240	65.6	71.7	79.8	2	35	0.05	47.6	0.25
75	70.0	79.0	95	255	73.4	80.2	88.6	2	35	0.05	52.5	0.2

# Voltage regulator diodes

BZV90 series

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	lead length max.; note 1	83.3	K/W

#### Note

1. Device mounted on an FR4 double-sided copper-clad printed circuit-board; copper area = 2 cm<sup>2</sup>.

#### **GRAPHICAL DATA**

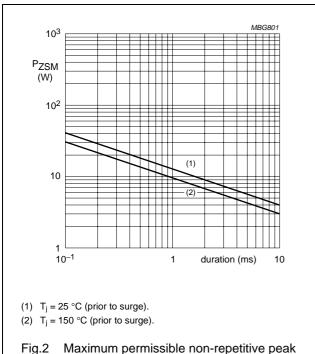


Fig.2 Maximum permissible non-repetitive peak reverse power dissipation versus duration.

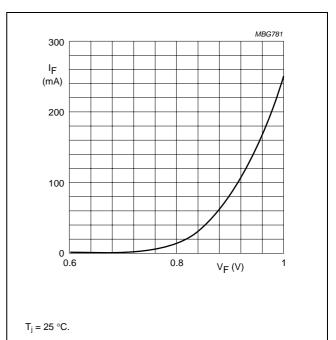


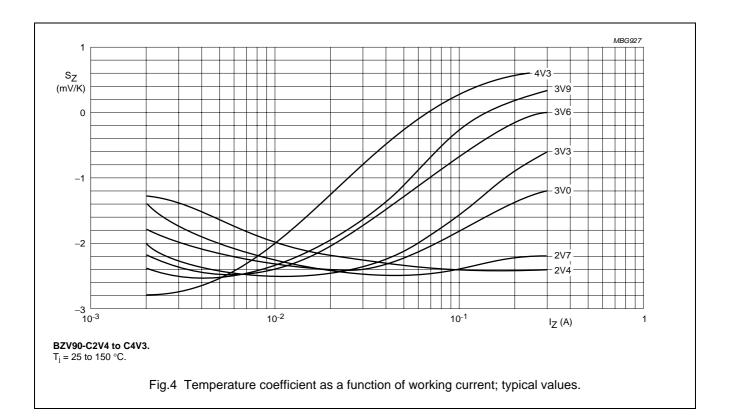
Fig.3 Forward current as a function of forward voltage; typical values.

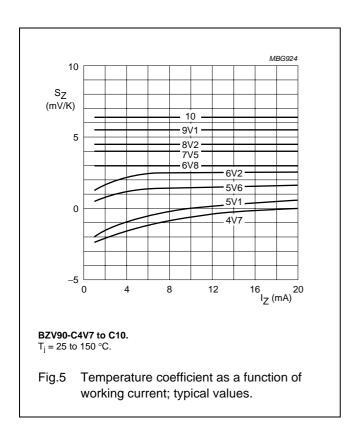
1999 May 17

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# Voltage regulator diodes

# BZV90 series





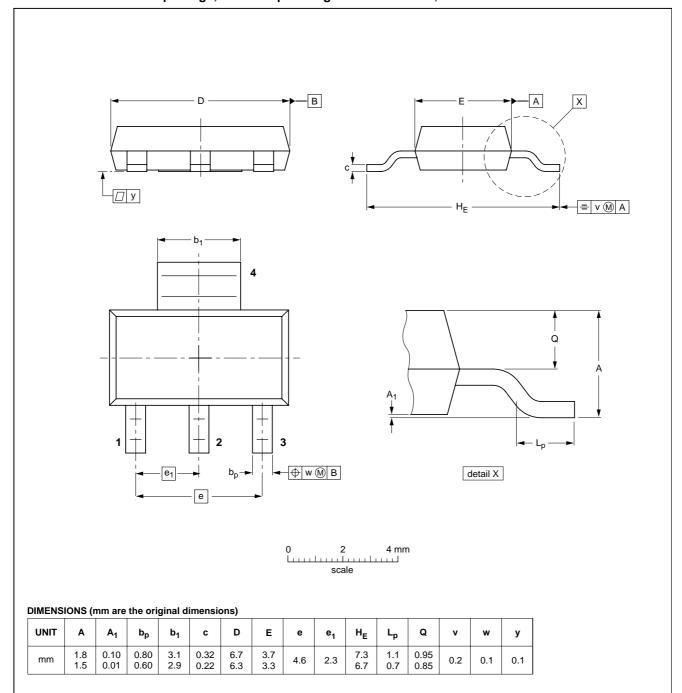
# Voltage regulator diodes

# BZV90 series

#### **PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

**SOT223** 



	OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
	VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
	SOT223			SC-73		<del>97-02-28</del> 99-09-13
,						

1999 May 17 7

#### Voltage regulator diodes

#### **BZV90** series

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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